

Product	LED
Package	LAMP
Series	SLR-322 * *

1.試験結果(Test Result)

試験項目	参考規格	試験条件	n	Pn	1
Test Items	Reference STD		(pcs)	(pcs)	
半田耐熱	JESD22-B106D	260±5℃のPbフリ-半田槽に	(= = = /	()	
		端子根元0mmまで10±1秒浸漬		-	
Solder Heat Resistance		Immerse the reverse side of the device on the surface	22	0	
for Reflow Soldering		of Pb−free solder bath at 260±5°C for 10±1sec			
半田付性	JESD22-B102E	ロジン系フラックスに5±1秒浸漬し、245±5℃の			
Solderbility		Pbフリー半田槽で製品裏面を3±0.5秒浸漬	00	0	*1
		Immerse into rosin flux for 5 ± 1 sec,and the device	22	0	™ 1
		for 3 ± 0.5 sec into Pb-free solder bath at $245\pm5^\circ$ C			
落下	JEITA ED-4701	高さ:75cm 楓板上:3回	22	0	
Free Drop	A-124	H=75cm Maple Boad : 3 times	22	U	
振動	JEITA ED-4701	100~2000Hz 98.1m/S ² X,Y,Zの各方向 2時間			
Vibration	A-121	100~2000Hz 98.1m/S ²	22	0	
		2hours each on each direction of X,Y,Z			
端子引張強度	JESD22-B105D	荷重:10N(1Kgf) 30秒	22	0	
Lead Pull Test		Load:10N(1Kgf) 30sec	22	0	
端子折曲げ強度	JESD22-B105D	荷重:1.25N(0.125Kgf) 0°~90°~0°~-90°~0°	22	0	
Lead Bend Test		Load: 1.25N(0.125Kgf) $0^{\circ} \sim 90^{\circ} \sim 0^{\circ} \sim -90^{\circ} \sim 0^{\circ}$	22	0	
温度サイクル	JESD22-A104E	Ta=Tstg Min.°C(30min.) ~ Tstg Max.°C(30min.)100cycle	22	0	
Thermal Cycle			22	Ũ	
高温放置	JESD22-A103E	Ta=Tstg Max.+5°C/-0°C 1000hrs			
High Temperature			22	0	
Strage					
高温高湿放置		Ta=85±2°C 85±5%RH 240hrs			
High Temperature	B-121		22	0	
High Humidity Strage					
低温放置	JESD22-A119A	Ta=Tstg Min.±5°C 1000hrs			
Low Temperature			22	0	
Strage		â			
動作寿命	JESD22-A108D	Ta=25±5°C IF=IFMAX 1000hrs	22	0	
Load Life				÷	

2.測定項目及び故障判定基準(Failure Criteria)

測定項目	測定条件	故障判定基準
Items	Condition Criteria	
光度	10mA	初期値の60%
Luminous Intensity	Luminous Intensity	
順方向電圧	10mA	初期値に対する変化率±10%
Forward Voltage		Changing rate of $\pm 10\%$
逆方向電流	VR=VR Max.	規格最大値
Reverse Current	Reverse Current	
外観	目視	著しい変化のないこと
Physical	Visual Check	No outstanding change in physical

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1 当日付性 Solderbility 低ore than 95% of the electrode must be covered with solder. ※当データは、特定Lotの実力値であり保証値ではありません。

%This data is actual value from specific lot and is not guaranteed.

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